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(54) A method of forming lines of weakness in or grooving a plastic material, especially a packaging material

Verfahren zum Herstellen von Schwächungslinien oder Rillen in Kunststoffmaterial, insbesondere Verpackungsmaterial

Procédé de formage de lignes d'affaiblissement ou de rainures dans de la matière plastique, plus particulièrement dans un matériau d'emballage

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- **G.T. ABSTEN 'Lasers in Medecine' 1985, CHAPMAN AND HALL, LONDON, GB**

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Description

This invention relates to a method of forming lines of weakness in a plastic material, especially a packaging material, by local vaporization or degradation by means of a laser beam, which laser beam and which plastic or packaging material can be moved in relation to each other. This method can also be used to groove a plastic material.

Such a method is known from U.S. patent 3,909,582. The laser beam is provided by a stationary CO_2 laser conventional for industrial applications, which CO_2 laser provides radiant energy at a constant wavelength of 10.6 microns. The packaging material is passed under the laser beam, with the rate of movement and consequently the processing speed being determined substantially by the radiation absorption capacity of the packaging material to be processed. This radiation absorption capacity is a property of materials which may have greatly varying values in different materials. A high absorption capacity means that the radiant energy supplied to the material is converted substantially into a weakening of materials by a form of energy effecting vaporization or degradation, e.g. heat. As a result, the processing speed of these materials is high. A low absorption capacity gives a low processing speed which in some packaging materials is so low that, in practice, it is difficult to form lines of weakness therein with the conventional CO_2 laser.

The object of this invention is to increase the processing speed of packaging materials or to enhance the processability of a series of materials that are difficult to weaken with a laser.

The method of the invention is characterized in that the laser beam is generated by means of a wavelength tunable laser tuned to a wavelength selected on the basis of the wavelength dependent absorption spectrum of the material to be processed. The wavelength is selected in such a manner that the product of the laser efficiency and the absorption value of the packaging material is highest at that selected wavelength.

The method of the invention will hereinbelow be illustrated with reference to the drawings and examples. In the drawings:

Fig. 1 is a graph in which the power supplied by a tunable CO_2 laser is plotted against the wavelength;
Fig. 2 is the wavelength power table belonging to Fig. 1 for the CO_2 isotope $C^{12}O_2{}^{16}$;
Fig. 3 is the transmission spectrum of a polypropylene film; and
Fig. 4 is the transmission spectrum of a polyester film.

Wavelength tunable CO_2 lasers

Such lasers are known per se. To date, they are used for scientific research. The range of operation of this type of CO_2 laser is between the wavelengths of 8.9-11.4 microns. By, e.g., rotating a diffraction grating placed at the end of the laser tube, the laser can be tuned to a certain wavelength within the above-indicated range. Not all wavelengths give laser action, and the power supplied by the laser depends on the selected wavelength. For a conventional CO_2 isotope - $C^{12}O_2{}^{16}$- it was found that there were 80 transitions or wavelengths distributed over four ranges 9R, 9P, 10R and 10P (see Fig. 1) in which laser action occurs. The power supplied by the laser or the efficiency depends on the wavelength. Shown in Table I (Fig. 2) are for a 60W CO_2 laser for the ranges 9R-10P the different transitions (column A) as well as the associate wavelengths in microns (column B), the reciprocal values thereof (column C), the power supplied (column D), and the efficiency (column E). As shown in Table I, the peaks of the ranges 9R, 9P, 10R and 10P are not at the same level, as shown in Fig. 1 for the sake of convenience.

When the CO_2 laser is filled with another isotope, e.g., $C^{13}O_2{}^{16}$ or $C^{12}O_2{}^{18}$, there proves to be a shift of the ranges 9R-10P with laser action within the wavelength range 8.9-11.4 microns, as shown in Fig. 1. At a wavelength of 10.6 microns a CO_2 laser with isotope $C^{12}O_2{}^{16}$ is found to supply a maximum power, the laser action at that wavelength being low for the isotope $C^{12}O_2{}^{18}$ and even non-existent for the isotope $C^{13}O_2{}^{16}$.

Absorption capacity of packaging material

Example I

U.S. patent 3,909,582 discloses that different packaging materials have absorption capacities different from each other for radiant energy having a wavelength of 10.6 microns. This absorption capacity is a measure of the processing speed when forming lines of weakness with a conventional untunable CO_2 laser (wavelength of 10.6 microns).

When packaging material is examined by means of an infrared spectrometer, the absorption capacity is found to depend strongly on the wavelength.

In Fig. 3 the curve of the transmission value (%) is plotted against the wavelength for a polypropylene film having a thickness of 20 microns. At the wavelength of 10.6 microns the transmission value is ±84%. Of the radiant energy supplied to the polypropylene film, 84% are found to pass through the material, only 16% of the energy supplied are partly reflected and partly absorbed in the polypropylene film. The amount of reflected energy can also be determined by means of an infrared spectrometer and varies within the wavelength range of 8.9-11.4 microns between 0 and 10%. Only ±11% of the energy supplied remains for absorption in the film. Consequently, the forming of lines of weakness in such a polypropylene film with a conventional CO_2 laser is a difficult and slow process.

The graph of Fig. 3 further shows two minima for the transmission value, namely 10.02 and 10.28

microns. The transmission value is then ±41% and the absorption value 100%-(41%+5%)=±54% or a factor of 5 greater than at the wavelength of 10.6 microns. If radiant energy having a wavelength of 10.02 or 10.28 microns is available, then the processability of the polypropylene film will be considerably increased.

Fig. 1 and Table 1 show that for the wavelength of 10.28 microns with a tunable CO_2 laser (isotope $C^{12}O_2{}^{16}$) a transition having a good efficiency (±85%) is available, but for the wavelength of 10.02 microns no laser action occurs, unless another gas fill (isotope $C^{13}O_2{}^{16}$) is selected.

Example II

In Fig. 4 the curve of the transmission value (%) is plotted against the wavelength for a polyester film (PET = polyethylene terephthalate) having a thickness of 12 microns. At a wavelength of 10.6 microns the transmission value is ±75%, so the absorption value is low. The transmission value graph shows three minima, namely at 9.81, 10.29, and 9.2-9.3 microns. The Table (Fig. 2) shows that at the wavelength of 10.28 microns the laser can supply a power of 49W. At the wavelength of 9.81 microns there is little or no laser action, while in the wavelength range of 9.2-9.3 microns several transitions can be selected with a high power supplied by the laser. Consequently, for processing the polyester film it is better to select the wavelength of 9.2-9.3 microns, because the product of laser efficiency x absorption value is higher at this wavelength than at the wavelength of 9.81 microns.

Examples I and II show what advantages can be obtained by using a tunable CO_2 laser to form lines of weakness in packaging materials in the form of a single film. Many packaging materials, however, are of complex composition and are composed of one or more layers of paper, cellophane, aluminium foil, polyethylene, polypropylene, cellulose triacetate, polyester, polyamides, PVC, PVDC, surlyn, polystyrene, with different layers being bonded together by means of adhesive, lacquer, plastic, wax, hot melt, and the like.

With these packaging materials of complex composition, the method of the invention offers the advantage that the tunable CO_2 laser is allowed to function at a wavelength at which one or more specific layers of the material are just vaporized or just not.

On the basis of this principle of just vaporizing or just not, tunable CO_2 and other types of lasers offer great advantages for the process of grooving signs in a coating applied to a carrier film. The laser is tuned to a wavelength at which the coating is processed but the carrier film is not affected.

The tunable CO_2 laser and also other tunable laser types offer great advantages for the process of grooving or applying marks in plastic products other than those in the form of a film which usually have a considerably greater thickness than the packaging materials in the form of a film. The absorption value of such products is usually 100% in view of their thickness, i.e. all the laser energy is absorbed in the product or, in other words, energy transmission takes place beyond the processing depth. With such products, not the wavelength dependent absorption value but the absorption value per unit of material thickness or the absorption constant (see U.S. patent 3,909,582 - Table I) should be taken as the starting point. This absorption constant is usually wavelength dependent too. In that case the tunable CO_2 or another type of laser is tuned as described above to such a wavelength that the combination of laser efficiency and absorption constant is highest for obtaining a maximum processing speed.

Claims

1. A method of forming lines of weakness in or grooving a plastic material, especially a packaging material, by local vaporization or degradation by means of a CO_2-laser beam, which laser beam and which plastic or packaging material can be moved in relation to each other, characterized in that the laser beam is generated by means of a wavelength tunable CO_2-laser tuned to a wavelength selected on the basis of the wavelength depending absorption spectrum of the material to be processed, at which wavelength the product of the laser efficiency and the absorption value of the packaging material has a maximum value.

2. A method of claim 1 in which the packaging material is composed of different layers of a composite complex material, characterized in that the tunable laser is tuned to a wavelength having a low absorption value for that layer of the complex material which has to remain practically unaffected when other layers are weakened.

3. A grooving method of claim 2, characterized in that the complex material is composed of a carrier film and a coating applied thereto, the laser being tuned to a wavelength having a high absorption value for the coating and a low absorption value for the carrier film.

Patentansprüche

1. Verfahren zum Bilden von Schwächungslinien in einem Kunststoffmaterial oder zum Einkerben eines Kunststoffmaterials, insbesondere eines Verpackungsmaterials, durch örtliche Verdampfung oder Abtragung mittels eines CO_2-Laserstrahls, wobei der Laserstrahl und das Kunststoff- oder Verpackungsmaterial in bezug aufeinander bewegt werden können, dadurch gekennzeichnet, daß der Laserstrahl mittels eines Wellenlängen - abstimmbaren CO_2-Lasers erzeugt wird, der auf eine Wellenlänge-abgestimmt ist, die auf der Basis der Wellenlänge gewählt ist, die von dem Absorptions-

spektrum des Materials, das bearbeitet werden soll, abhängig ist, bei welcher Wellenlänge das Produkt aus dem Laserwirkungsgrad und dem Absorptionswert des Verpackungsmaterials einen Maximalwert aufweist.

2. Verfahren nach Anspruch 1, bei welchem das Verpackungsmaterial aus unterschiedlichen Schichten eines komplexen Verbundmaterials zusammengesetzt ist, dadurch gekennzeichnet, daß der abstimmbare Laser auf eine Wellenlänge abgestimmt ist die einen niedrigen Absorptionswert für die Schicht des komplexen Materials aufweist, die praktisch unangegriffen bleiben soll, wenn andere Schichten geschwächt werden.

3. Einkerbungsverfahren nach Anspruch 2, dadurch gekennzeichnet, daß das komplexe Material aus einem Trägerfilm und einer darauf aufgetragenen Beschichtung zusammengesetzt ist, und der Laser auf eine Wellenlänge abgestimmt ist, die einen hohen Absorptionswert für die Beschichtung und einen niedrigen Absorptionswert für den Trägerfilm aufweist.

Revendications

1. Procédé de formation de lignes d'affaiblissement ou de rainures dans une matière plastique, en particulier une matière pour emballage par vaporisation ou dégradation locale au moyen d'un faisceau laser à CO_2, ledit faisceau laser et ladite matière plastique ou matière pour emballage pouvant être déplacés l'un par rapport à l'autre, procédé caractérisé en ce que le faisceau laser est produit par un laser à CO_2, accordable en longueur d'onde, réglé à une longueur d'onde que l'on choisit en se basant sur le spectre d'absorption en fonction de la longueur d'onde de la matière à traiter, cette longueur d'onde étant celle à laquelle le produit de l'efficacité du laser par le coefficient d'absorption de la matière pour emballage présente une valeur maximale.

2. Procédé selon la revendication 1, dans lequel la matière pour emballage est constituée des différentes couches d'une matière complexe composite, caractérisé en ce que le laser accordable est réglé à une longueur d'onde correspondant à un faible coefficient d'absorption de la couche de la matière complexe qui doit rester pratiquement inchangée lorsque d'autres couches sont affaiblies.

3. Procédé de formation de rainures selon la revendication 2, caractérisé en ce que la matière complexe est constituée d'un film support et d'un revêtement appliqué dessus, et le laser est réglé à une longueur d'onde à laquelle le revêtement présente un fort coefficient d'absorption et le film support présente un faible coefficient d'absorption.

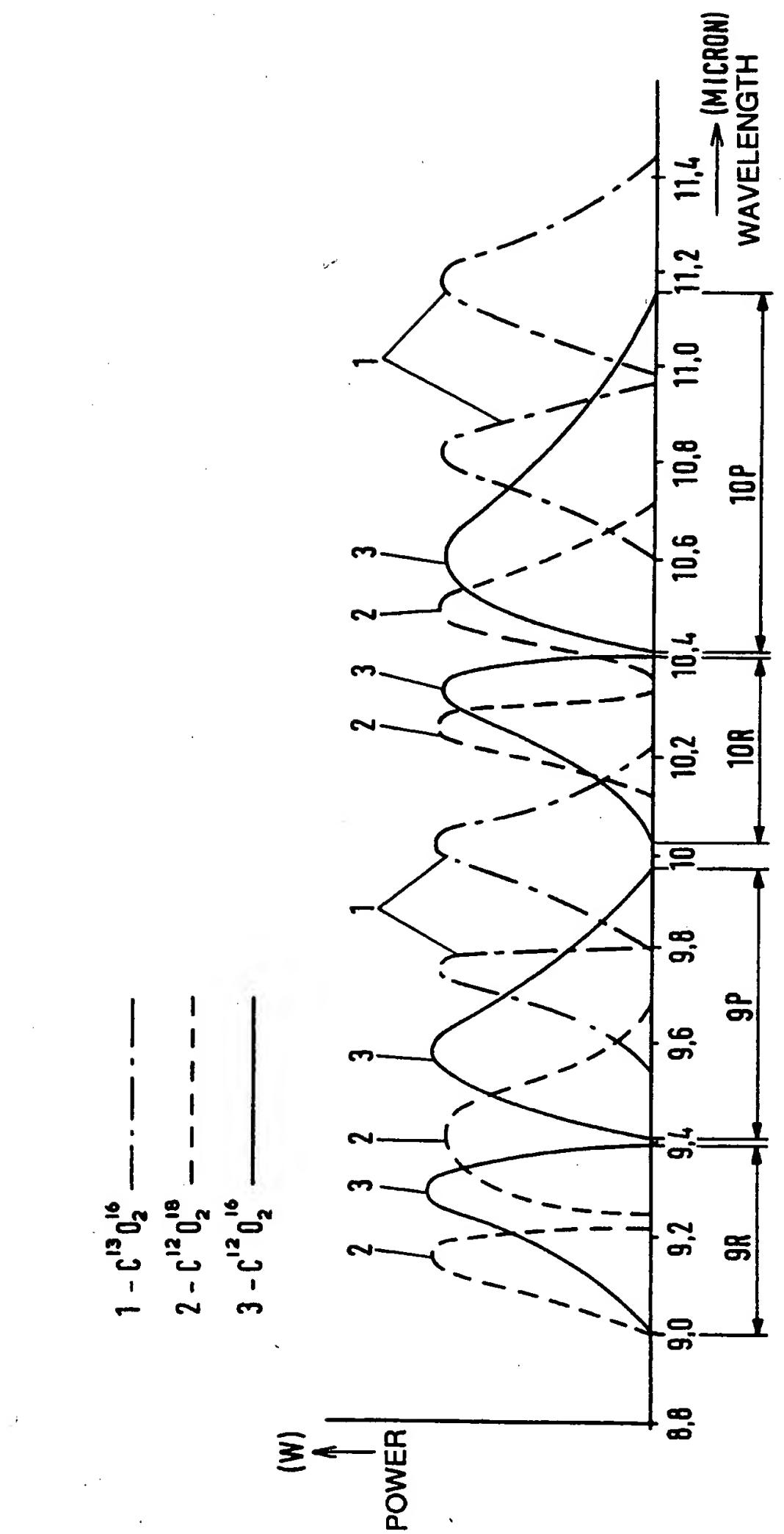

1 - $C^{13}O_2^{16}$
2 - $C^{12}O_2^{18}$
3 - $C^{12}O_2^{16}$
POWER (W)
WAVELENGTH (MICRON)
8,8
9,0
9,2
9,4
9,6
9,8
10
10,2
10,4
10,6
10,8
11,0
11,2
11,4
9R
9P
10R
10P
1
2
3

FIG.1

ISOTOPE $C^{12}O_2^{16}$

Line	Wavelength mμ	Wavelength cm^{-1}	Power Watt	Eff. %
9P46	9,794	1021,06	13,5	22
44	9,773	1023,19	22,0	37
42	9,753	1025,30	29,0	48
40	9,733	1027,38	36,5	61
38	9,714	1029,44	38,0	63
36	9,695	1031,48	42,0	70
34	9,676	1033,49	44,0	73
32	9,657	1035,47	48,0	80
30	9,639	1037,43	50,0	83
28	9,621	1039,37	51,5	86
26	9,604	1041,28	53,0	88
24	9,586	1043,16	53,0	88
22	9,569	1045,02	53,0	88
20	9,552	1046,86	55,0	92
18	9,536	1048,66	56,0	93
16	9,519	1050,44	52,5	87
14	9,504	1052,20	48,5	81
12	9,488	1053,92	48,5	81
10	9,473	1055,63	42,0	70
8	9,458	1057,30	35,0	58
6	9,443	1058,95	10,5	18

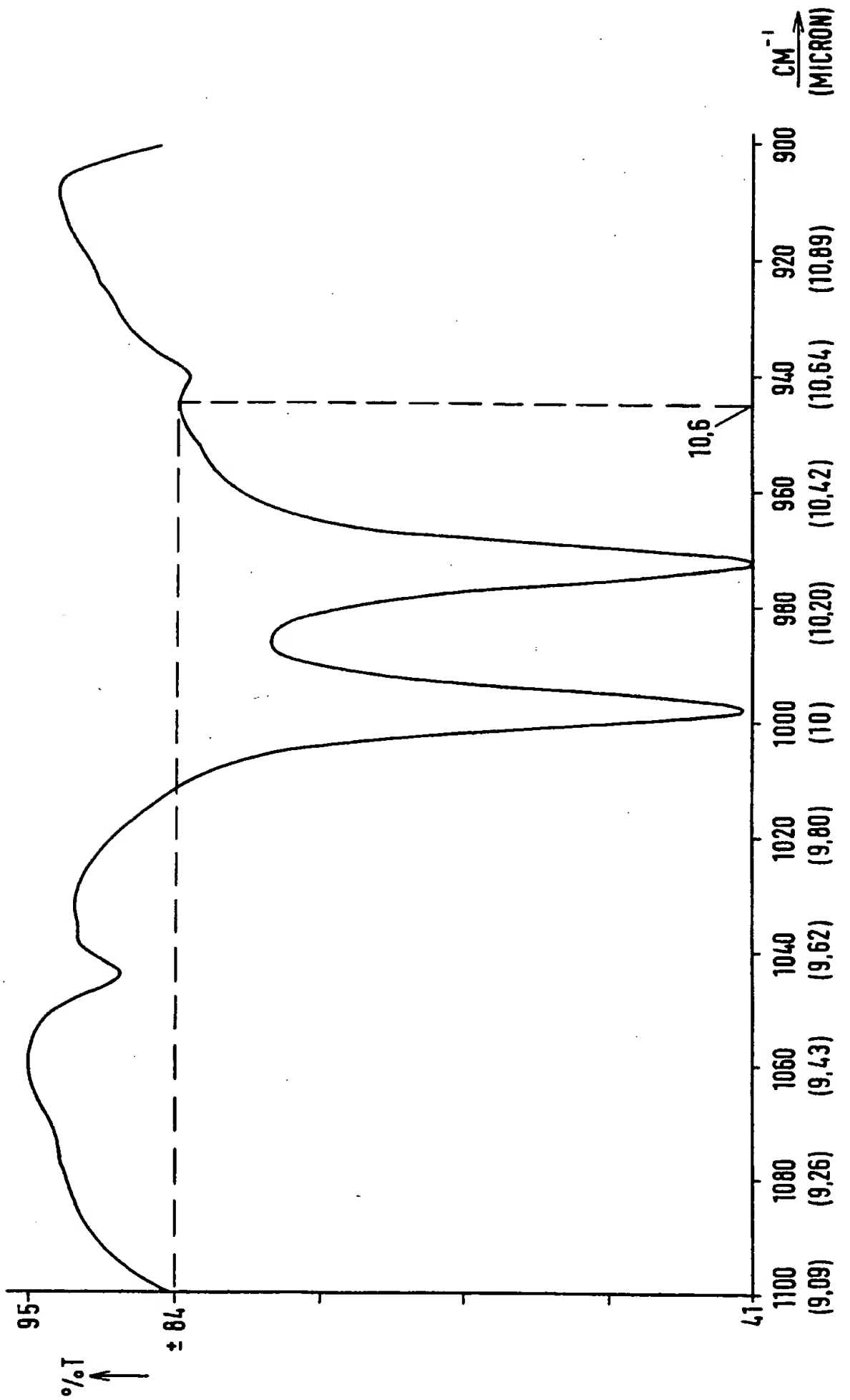
Line	Wavelength mμ	Wavelength cm^{-1}	Power Watt	Eff. %
9R4	9,367	1067,53	8,0	13
6	9,354	1069,01	28,0	47
8	9,342	1070,46	38,0	63
10	9,329	1071,88	45,0	75
12	9,317	1073,28	50,5	84
14	9,305	1074,65	54,0	90
16	9,294	1075,99	57,0	95
18	9,282	1077,30	58,0	97
20	9,271	1078,59	57,5	96
22	9,261	1079,85	57,5	96
24	9,249	1081,09	60,0	100
26	9,239	1082,30	54,0	90
28	9,229	1083,48	53,0	88
30	9,219	1084,64	48,5	81
32	9,210	1085,77	50,0	83
34	9,201	1086,87	46,0	77
36	9,192	1087,95	42,0	70
38	9,183	1089,00	35,0	58
40	9,174	1090,03	28,5	47
42	9,166	1091,03	15,5	26
44	9,157	1092,01	5,0	8

Line	Wavelength mμ	Wavelength cm^{-1}	Power Watt	Eff. %
10P46	10,885	918,72	9,5	16
44	10,860	920,83	18,0	30
42	10,835	922,92	26,0	43
40	10,811	924,97	30,0	50
38	10,787	927,01	34,5	57
36	10,764	929,02	38,0	63
34	10,741	931,00	40,0	67
32	10,719	932,95	42,0	70
30	10,696	934,90	45,0	75
28	10,675	936,80	46,5	77
26	10,635	938,69	48,0	80
24	10,632	940,55	48,0	80
22	10,611	942,38	49,0	82
20	10,591	944,19	51,0	85
18	10,571	945,98	49,0	82
16	10,551	947,74	47,5	79
14	10,532	949,48	47,0	79
12	10,513	951,19	45,0	75
10	10,494	952,88	41,0	69
8	10,476	954,55	36,0	60
6	10,458	956,19	22,0	37

ISOTOPE $C^{12}O_2^{16}$

Line	Wavelength mμ	Wavelength cm^{-1}	Power Watt	Eff. %
10R4	10,365	964,77	8,0	13
6	10,349	966,25	29,0	49
8	10,334	967,71	37,5	62
10	10,318	969,14	43,0	71
12	10,303	970,55	47,0	79
14	10,289	971,93	49,0	81
16	10,274	973,29	50,0	83
18	10,261	974,62	50,5	84
20	10,247	975,93	50,0	83
22	10,233	977,21	50,5	84
24	10,220	978,47	50,5	84
26	10,207	979,71	50,5	84
28	10,195	980,91	48,0	80
30	10,182	982,10	45,5	75
32	10,170	983,25	43,5	72
34	10,159	984,38	41,0	69
36	10,147	985,49	37,0	61
38	10,136	986,57	33,0	55
40	10,125	987,62	27,0	45
42	10,115	988,65	19,5	32
44	10,105	989,65	11,0	19

FIG.2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(MICRON)
900
920
(10,89)
940
(10,64)
10,6
960
(10,42)
980
(10,20)
1000
(10)
1020
(9,80)
1040
(9,62)
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(9,43)
1080
(9,26)
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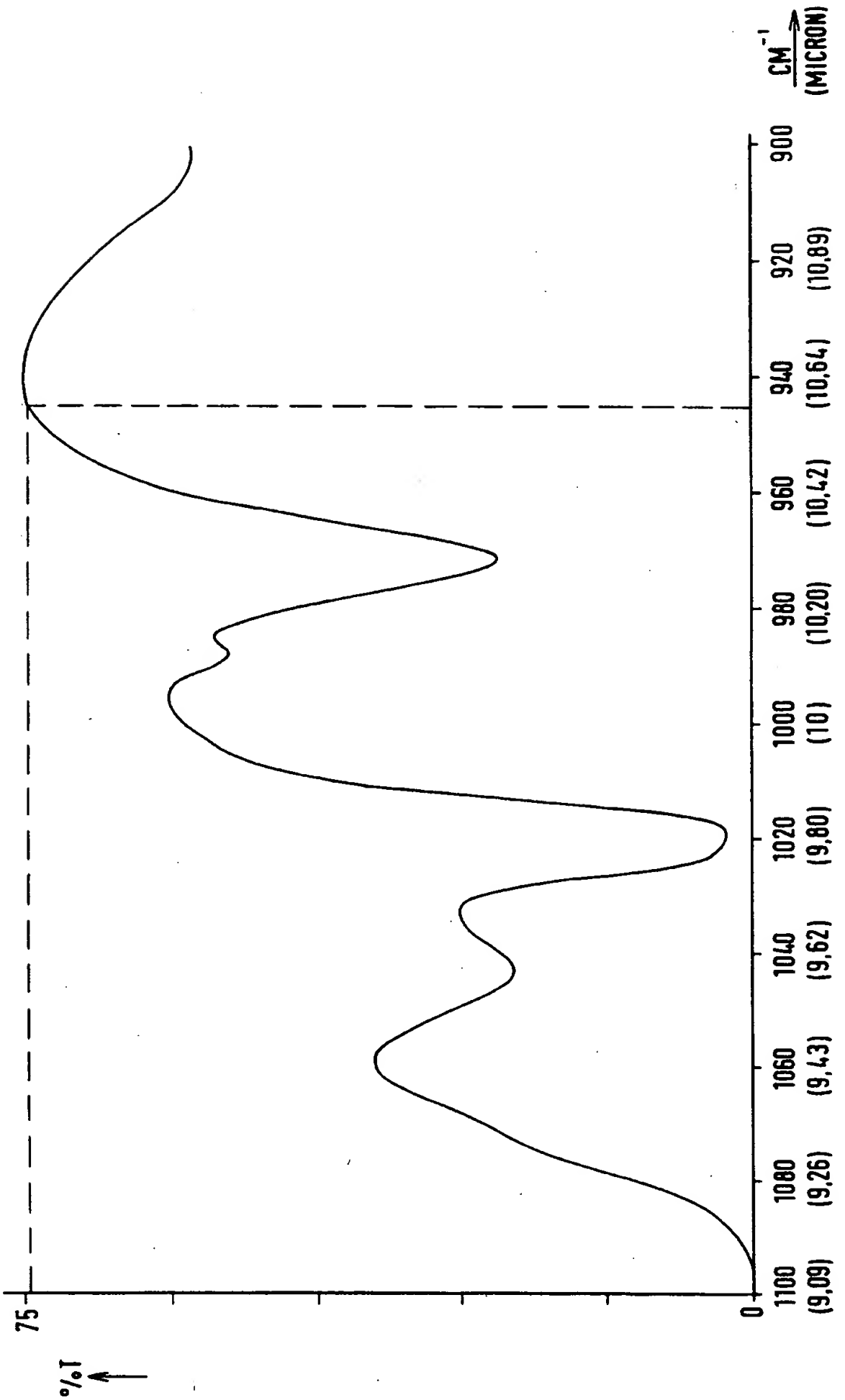
(9,09)
95
± 84
41
%T

FIG.3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(MICRON)
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1080 (9,26)
1100 (9,09)
75
0
%I

FIG.4